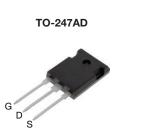
### SiHW70N60EF

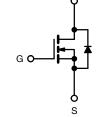
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**Vishay Siliconix** 

# **EF Series Power MOSFET with Fast Body Diode**

PRODUCT SUMMA	RY	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650	)
R <sub>DS(on)</sub> typ. at 25 °C (Ω)	$V_{GS} = 10 V$	0.033
Q <sub>g</sub> (Max.) (nC)	380	)
Q <sub>gs</sub> (nC)	62	
Q <sub>gd</sub> (nC)	102	2
Configuration	Sing	le





N-Channel MOSFET

#### **FEATURES**

- Fast body diode MOSFET using E series technology
- Reduced  $t_{rr}$ ,  $Q_{rr}$ , and  $I_{RRM}$
- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- Increased robustness due to low Q<sub>rr</sub>
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Telecommunications
  - Server and telecom power supplies
- Lighting
  - High intensity discharge (HID)
  - Light emitting diodes (LEDs)
- Consumer and computing
  - ATX power supplies
- Industrial
  - Welding
  - Battery chargers
- Renewable energy
  - Solar (PV inverters)
- Switch mode power suppliers (SMPS)
- Applications using the following topologies
  - LLC
  - Phase shifted bridge (ZVS)
  - 3-level inverter
  - AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and Halogen-free	SiHW70N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> =	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	600	v	
Gate-Source Voltage			V <sub>GS</sub>	± 30	v
Continuous Drain Current (T. 150 °C)	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	I <sub>D</sub>	70	
Continuous Drain Current ( $T_J = 150 \ ^\circ$ C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		45	А
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	229	1
Linear Derating Factor				4.2	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	1706	mJ
Maximum Power Dissipation		P <sub>D</sub>	520	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope $T_J = 125 \text{ °C}$		dV/dt	70		
Reverse Diode dV/dt <sup>d</sup>			50	V/ns	
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for	10 s		300	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 28.2 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 11$  A

c. 1.6 mm from case

d.  $I_{SD} = 35$  A, dl/dt = 750 A/µs,  $V_{DS} = 400$  V

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COMPLIANT HALOGEN

FREE



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.24	0/W

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.69	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V
Cata Sauraa Laakaga	I		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
Zero Gate Voltage Drain Current	la a a	V <sub>DS</sub> =	= 480 V, V <sub>GS</sub> = 0 V	-	-	1	μA
zero date voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 480 V$	∕, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	2	mA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 35 A	-	0.033	0.038	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 35 A	-	25	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		7500	-	
Output Capacitance	Coss		V <sub>DS</sub> = 100 V,	-	378	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		f = 1 MHz	-	5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>			-	263	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$v_{GS} = 0$	$V, V_{\rm DS} = 0 V \text{ to } 480 V$	-	926	-	
Total Gate Charge	Qg			-	253	380	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	$I_D = 35 \text{ A}, V_{DS} = 480 \text{ V}$	-	62	-	nC
Gate-Drain Charge	Q <sub>gd</sub>			-	102	-	
Turn-On Delay Time	t <sub>d(on)</sub>			-	56	84	
Rise Time	t <sub>r</sub>		: 480 V, I <sub>D</sub> = 35 A	-	107	161	
Turn-Off Delay Time	t <sub>d(off)</sub>	R <sub>g</sub> = 9	$R_{g} = 9.1 \Omega, V_{GS} = 10 V$		257	386	ns
Fall Time	t <sub>f</sub>	1		-	123	185	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.5	1.1	2.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET syml showing the	MOSFET symbol		-	70	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral revers p - n junction		-	-	229	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °0	C, I <sub>S</sub> = 35 A, V <sub>GS</sub> = 0 V	-	0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>			-	213	426	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 35 \text{ A},$ dl/dt = 100 A/µs, V <sub>R</sub> = 400 V		-	1.6	3.2	μC
Reverse Recovery Current	I <sub>RRM</sub>			-	16	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$  b.  $C_{oss(tr)}$  is a fixed capacitance that gives the charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

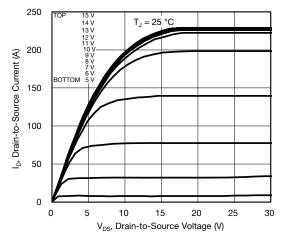
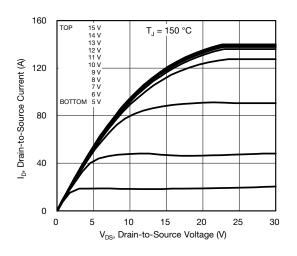


Fig. 1 - Typical Output Characteristics





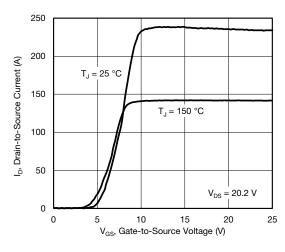


Fig. 3 - Typical Transfer Characteristics

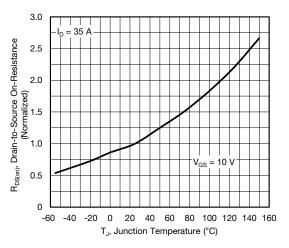


Fig. 4 - Normalized On-Resistance vs. Temperature

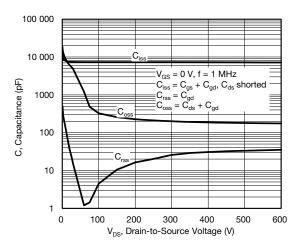


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

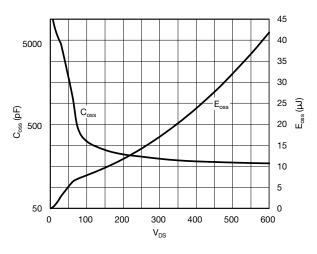


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

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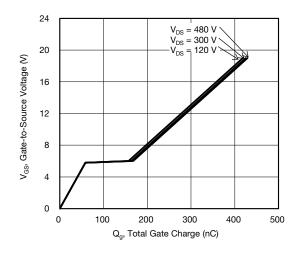


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

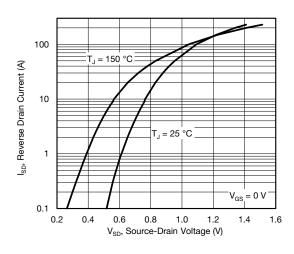


Fig. 8 - Typical Source-Drain Diode Forward Voltage

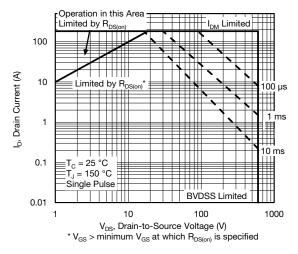


Fig. 9 - Maximum Safe Operating Area

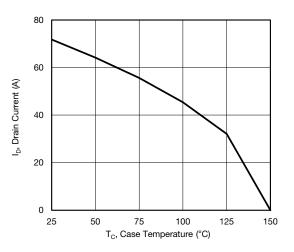


Fig. 10 - Maximum Drain Current vs. Case Temperature

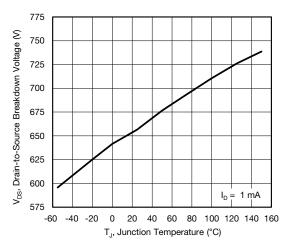
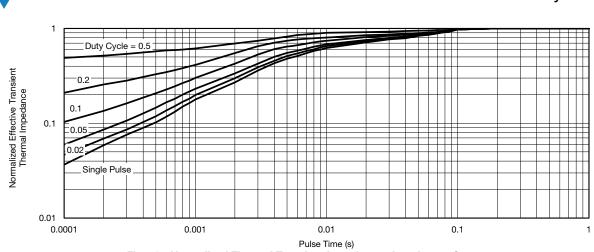
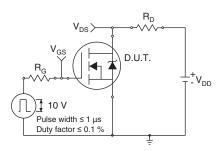


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature







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Fig. 13 - Switching Time Test Circuit

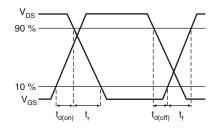


Fig. 14 - Switching Time Waveforms

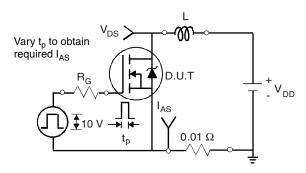


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

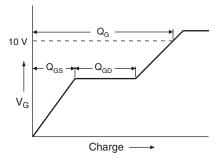
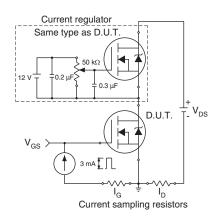


Fig. 17 - Basic Gate Charge Waveform





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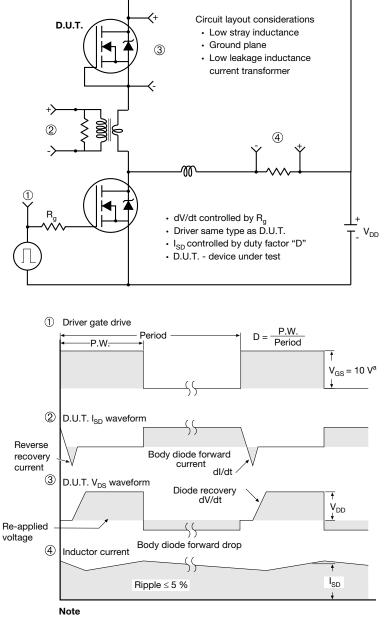
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5$  V for logic level devices

Fig. 19 - For N-Channel

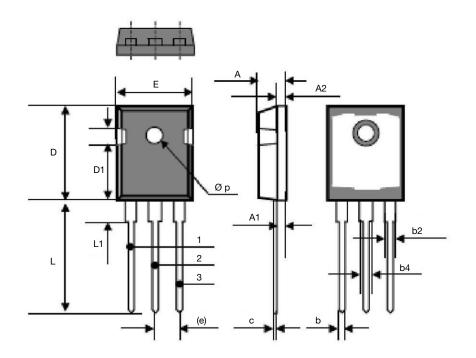
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# TO-247AD (High Voltage)



DIM.	MILLIN	<b>METERS</b>	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.70	5.31	0.185	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b2	1.65	2.41	0.065	0.095	
b4	2.59	3.43	0.102	0.135	
С	0.61	BSC	0.024 BSC		
D	20.80	21.46	0.819	0.845	
D1	3.68	5.49	0.145	0.216	
(e)	5.46	BSC	0.215	BSC	
E	15.49	16.26	0.610	0.640	
L	19.81	20.32	0.780	0.800	
L1	4.06	4.50	0.160	0.177	
Øp	3.51	3.66	0.138	0.144	

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